

N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

$V_{(BR)DSS}$	$R_{DS(ON)}$ max	I_D max $T_A = +25^\circ C$
30V	28m Ω @ $V_{GS} = 10V$	5.8A
	42m Ω @ $V_{GS} = 4.5V$	4.8A
	82m Ω @ $V_{GS} = 3V$	2.0A

Description

This MOSFET has been designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Battery Charging
- Power Management Functions
- DC-DC Converters
- Portable Power Adaptors

Features and Benefits

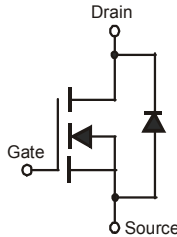
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**
- Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

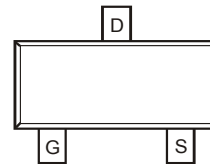
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish — Matte Tin annealed over Copper leadframe.
Solderable per MIL-STD-202, Method 208 **(e3)**
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (approximate)



Top View



Internal Schematic



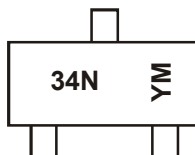
Top View

Ordering Information (Note 4 & 5)

Part Number	Compliance	Case	Packaging
DMN3404L-7	Standard	SOT23	3000/Tape & Reel
DMN3404LQ-7	Automotive	SOT23	3000/Tape & Reel

- Notes:
- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 - See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
 - For packaging details, go to Diodes website at <http://www.diodes.com/products/packages.html>.

Marking Information



34N = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: W = 2009)
 M = Month (ex: 9 = September)

Date Code Key

Year	2009	2010	2011	2012	2013	2014	2015
Code	W	X	Y	Z	A	B	C

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage (Note 6 & 7)			VDSS	30	V
Gate-Source Voltage			VGSS	±20	V
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	T _A = -40°C	I _D	4.6	A
		T _A = +25°C		4.2	
		T _A = +85°C		3.0	
Continuous Drain Current (Note 7) V _{GS} = 10V	Steady State	T _A = -40°C	I _D	6.2	A
		T _A = +25°C		5.8	
		T _A = +85°C		4.0	
Continuous Drain Current (Note 7) V _{GS} = 4.5V	Steady State	T _A = -40°C	I _D	5.2	A
		T _A = +25°C		4.8	
		T _A = +85°C		3.2	
Continuous Drain Current (Note 7) V _{GS} = 3V	Steady State	T _A = -40°C	I _D	2.2	A
		T _A = +25°C		2.0	
		T _A = +85°C		1.0	
Pulsed Drain Current			I _{DM}	30	A

Thermal Characteristics

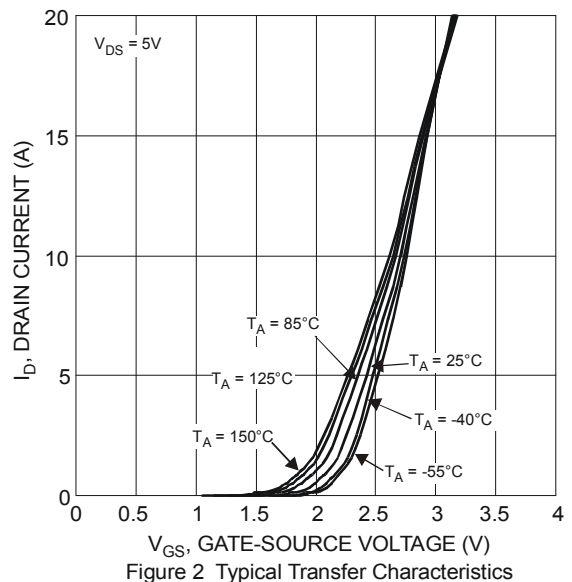
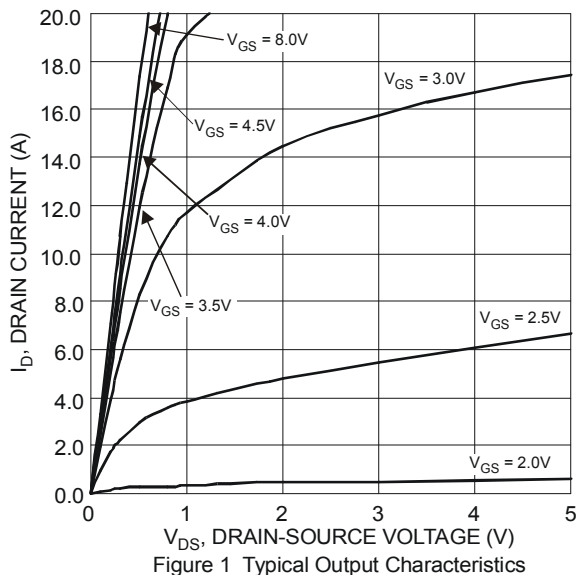
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	0.72	W
Thermal Resistance, Junction to Ambient @T _A = +25°C	R _{θJA}	173	°C/W
Power Dissipation (Note 7)	P _D	1.4	W
Thermal Resistance, Junction to Ambient @T _A = +25°C	R _{θJA}	90	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes: 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	30	—	—	V	V _{GS} = 0V, I _D = 250μA
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	—	—	1.0	μA	V _{DS} = 30V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	V _{GS} = ±20V, V _{DS} = 0V
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(th)}	1.0	1.5	2.0	V	V _{DS} = V _{GS} , I _D = 250μA
Static Drain-Source On-Resistance T _J = -40°C (Note 9)	R _{DS(on)}	—	23	27	—	V _{GS} = 4.5V, I _D = 4.8A
		—	57	74	—	V _{GS} =3V, I _D =2A
Static Drain-Source On-Resistance T _J = +25°C	R _{DS(on)}	—	24	28	mΩ	V _{GS} = 10V, I _D = 5.8A
		—	33	42		V _{GS} = 4.5V, I _D = 4.8A
		—	63	82		V _{GS} =3V, I _D =2A
Static Drain-Source On-Resistance T _J = +85°C (Note 9)	R _{DS(on)}	—	71	95	mΩ	V _{GS} =3V, I _D =2A
Forward Transfer Admittance	Y _{fs}	—	10	—	S	V _{DS} = 5V, I _D = 5.8A
Diode Forward Voltage	V _{SD}	—	0.75	1.0	V	V _{GS} = 0V, I _S = 1A
DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	C _{iss}	—	498	—	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	C _{oss}	—	52	—	pF	
Reverse Transfer Capacitance	C _{rss}	—	45	—	pF	
Gate Resistance	R _g	—	1.75	2.8	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz
Total Gate Charge (V _{GS} = 3V)	Q _g	—	3.8	5.3	nC	V _{GS} = 3V, V _{DS} = 15V, I _D = 1A
Total Gate Charge (V _{GS} = 4.5V)	Q _g	—	5.3	7.5	nC	
Total Gate Charge (V _{GS} = 10V)	Q _g	—	11.3	16	nC	
Gate-Source Charge	Q _{gs}	—	1.4	—	nC	
Gate-Drain Charge	Q _{gd}	—	2.1	—	nC	V _{DD} = 15V, V _{GS} = 10V, R _L = 2.6Ω, R _G = 3Ω
Turn-On Delay Time	t _{D(on)}	—	3.41	10	ns	
Turn-On Rise Time	t _r	—	6.18	13	ns	
Turn-Off Delay Time	t _{D(off)}	—	13.92	28	ns	
Turn-Off Fall Time	t _f	—	2.84	10	ns	

- Notes:
- 8. Short duration pulse test used to minimize self-heating effect.
 - 9. Guaranteed by design and 25°C data. Not subject to production testing
 - 10. Guaranteed by design. Not subject to production testing.



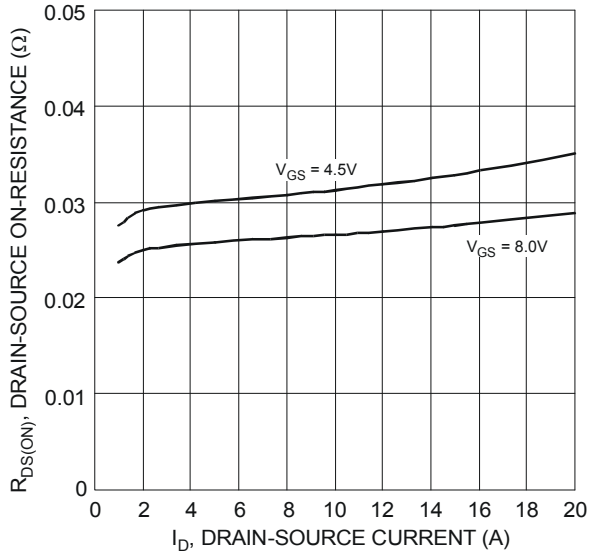


Figure 3 Typical On-Resistance vs. Drain Current and Gate Voltage

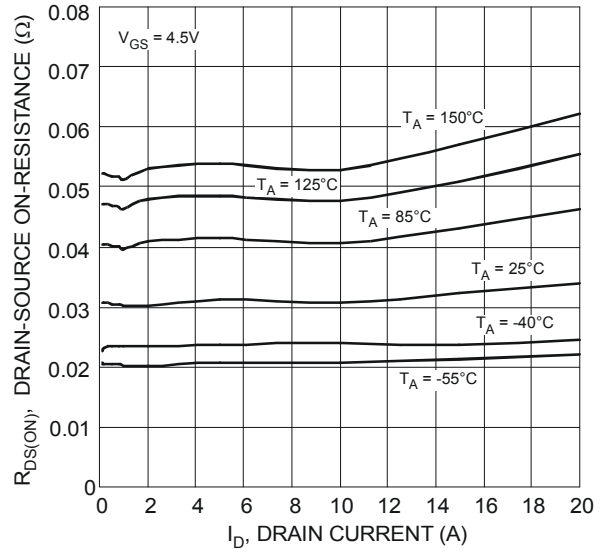


Figure 4 Typical On-Resistance vs. Drain Current and Temperature

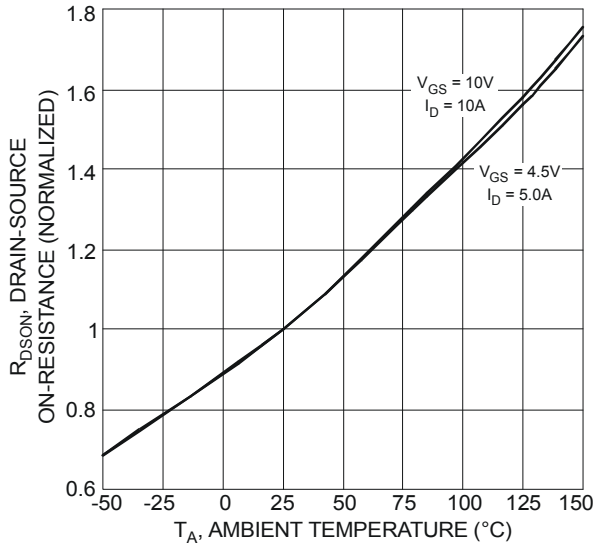


Figure 5 On-Resistance Variation with Temperature

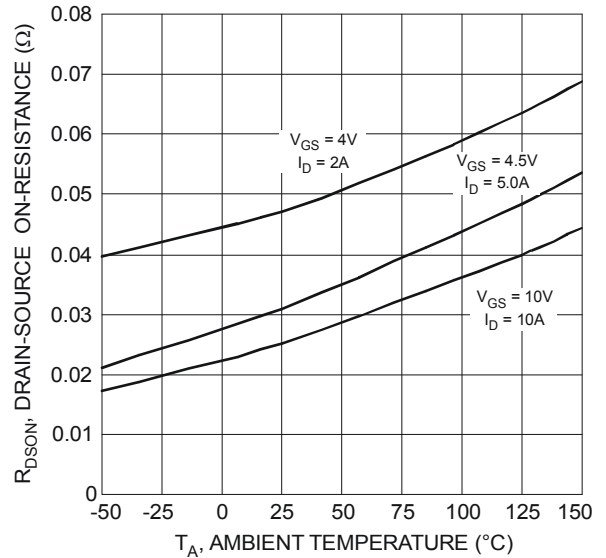


Figure 6 On-Resistance Variation with Temperature

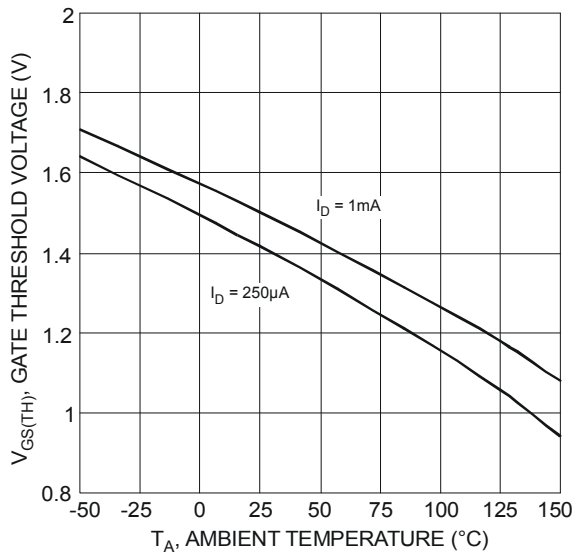


Figure 7 Gate Threshold Variation vs. Ambient Temperature

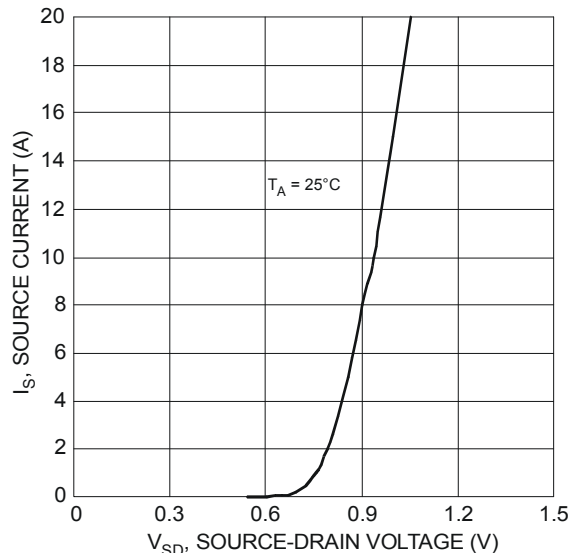


Figure 8 Diode Forward Voltage vs. Current

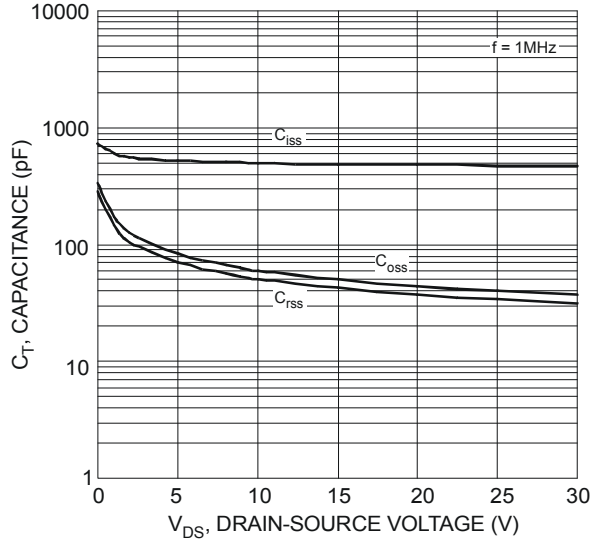


Figure 9 Typical Total Capacitance

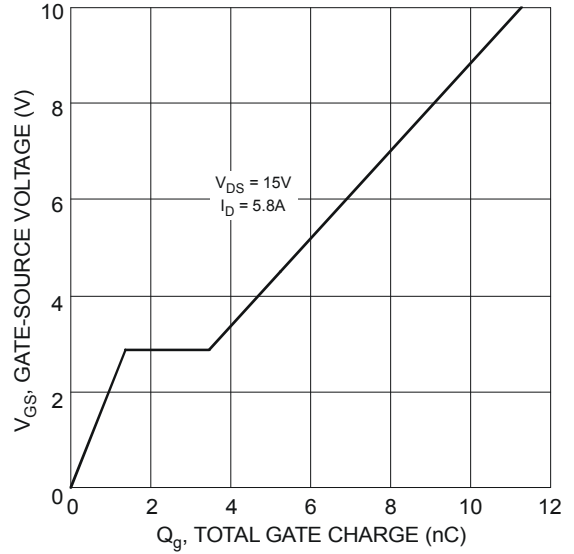


Figure 10 Gate-Charge Characteristics

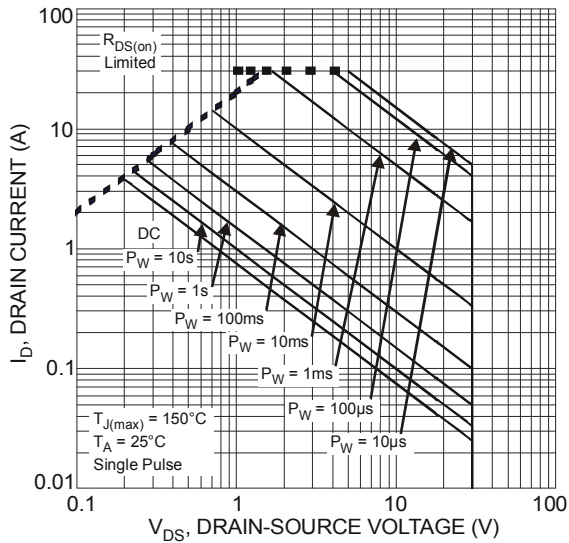


Figure 11 Safe Operation Area

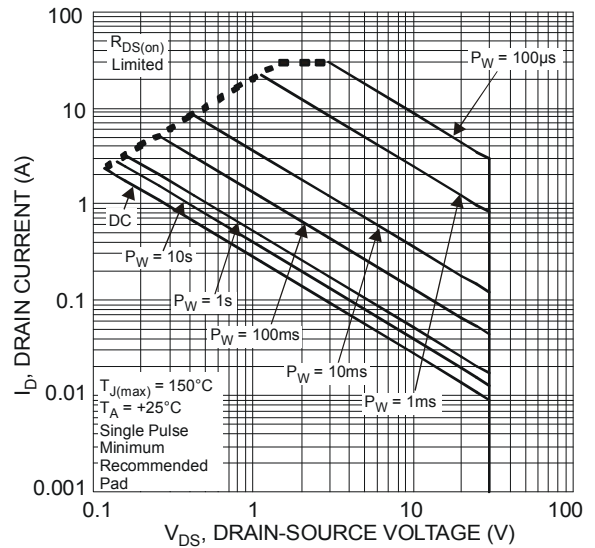


Figure 12 Safe Operation Area

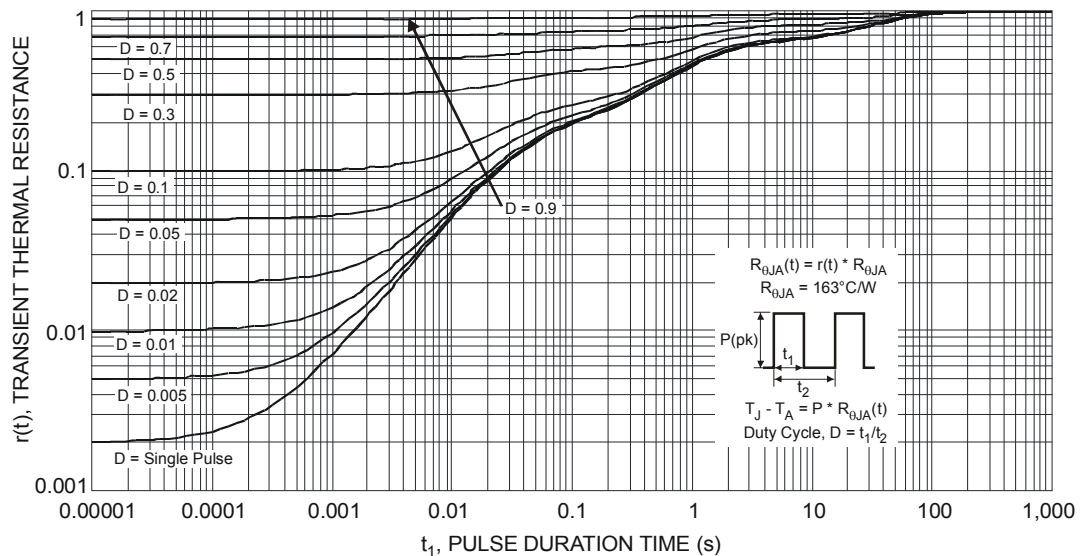
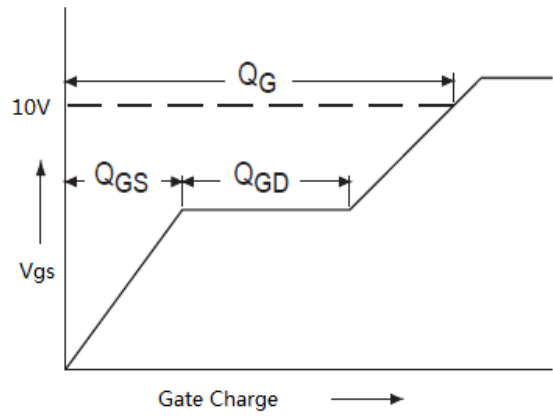
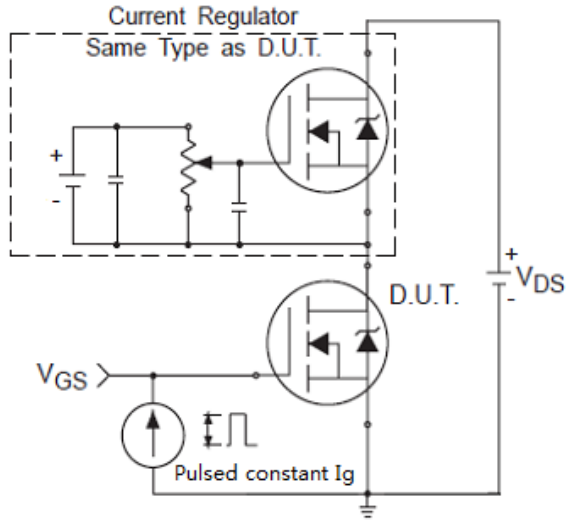
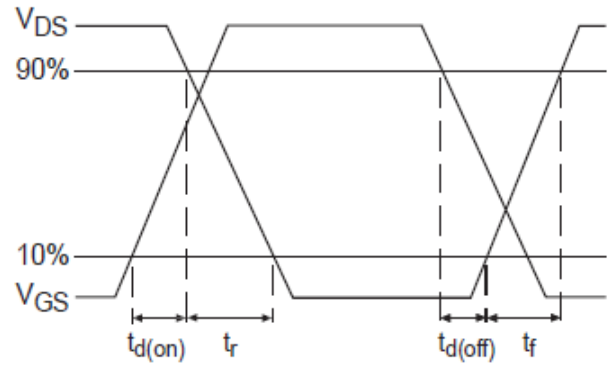
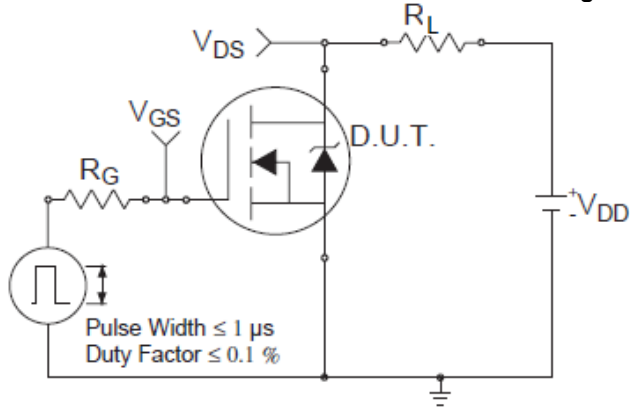


Figure 13 Transient Thermal Response

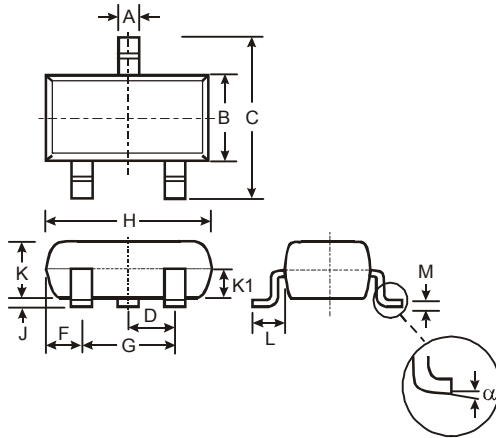
Gate Charge Test Circuit and Waveform



Switching Test Circuit and Waveform

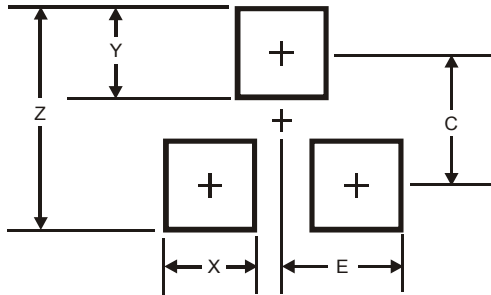


Package Outline Dimensions



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.903	1.10	1.00
K1	-	-	0.400
L	0.45	0.61	0.55
M	0.085	0.18	0.11
α	0°	8°	-
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

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Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.